

*8/Pre-
Am 4
a*

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:)
RAINERI ET AL.)
Serial No. **Not Yet Assigned**)
Filing Date: **Herewith**)
For: **A METHOD FOR MANUFACTURING**)
ISOLATING STRUCTURES)

I HEREBY CERTIFY THIS PAPER OR FEE IS BEING
DEPOSITED WITH THE U.S. POSTAL SERVICE
"EXPRESS MAIL POST OFFICE TO ADDRESSEE"
SERVICE UNDER 37 CFR 1.10 ON THE DATE
INDICATED BELOW AND IS ADDRESSED TO:
BOX PATENT APPLICATIONS, ASSISTANT
COMMISSIONER FOR PATENTS, WASHINGTON,
D.C. 20231.

EXPRESS MAIL NO: EL747059970US

DATE OF DEPOSIT: February 20, 2002

NAME: Dawn Kimler

SIGNATURE: Dawn Kimler

PRELIMINARY AMENDMENT

Director, U.S. Patent and Trademark Office
Washington, D.C. 20231

Sir:

Prior to the calculation of fees and examination of
the present application, please enter the amendments and
remarks set out below.

In the Drawings:

Submitted herewith is a request for a proposed
drawing modification as indicated in red ink to add a missing
reference numeral and to remove an extraneous marking from
FIG. 2. FIGS. 1 and 3-20 are also being modified as indicated
in red ink to remove extraneous markings therefrom.

In the Specification:

Please replace the paragraph beginning at page 2,
line 13, with the following rewritten paragraph:

On
-- One aspect of the invention is directed to a
method for forming isolating structures in a silicon carbide
layer. The method comprises depositing a masking layer on